## **DB3X313K**

### Silicon epitaxial planar type

For small current rectification DB2J313 in Mini3 type package

#### ■ Features

- $\bullet$  Low forward voltage  $V_{\text{F}}$  and small reverse current  $I_{\text{R}}$
- Low terminal capacitance C<sub>t</sub>
- Halogen-free / RoHS compliant
   (EU RoHS / UL-94 V-0 / MSL: Level 1 compliant)

#### ■ Marking Symbol: 4J

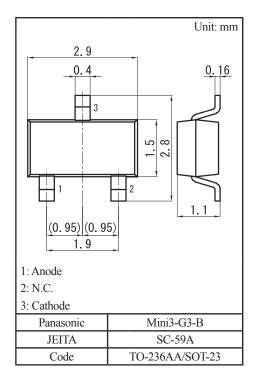
#### ■ Packaging

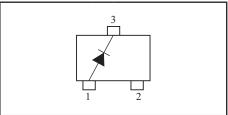
DB3X313K0L Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

#### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol Rating		Unit	
Reverse voltage	V <sub>R</sub>	30	V	
Repetitive peak reverse voltage	V <sub>RRM</sub>	30	V	
Forward current (Average)	I <sub>F(AV)</sub>	200	mA	
Peak forward current	$I_{FM}$	300	mA	
Non-repetitive peak forward surge current *1	I <sub>FSM</sub>	1	A	
Junction temperature	$T_{j}$	125	°C	
Operating ambient temperature	T <sub>opr</sub>	-40 to +85	°C	
Storage temperature	T <sub>stg</sub>	-55 to +125	°C	





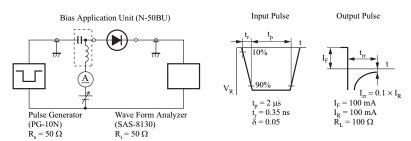


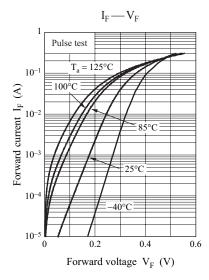
### ■ Electrical Characteristics $T_a = 25$ °C±3°C

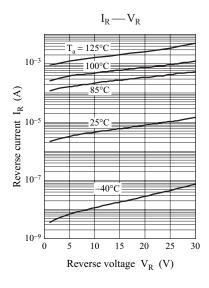
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V <sub>F</sub>	$I_F = 200 \text{ mA}$			0.55	V
Reverse current	$I_R$	$V_R = 30 \text{ V}$			50	μΑ
Terminal capacitance	C <sub>t</sub>	$V_R = 10 \text{ V}, f = 1 \text{ MHz}$		3.8		pF
Reverse recovery time *1	t <sub>rr</sub>	$\begin{aligned} I_F &= I_R = 100 \text{ mA}, I_{rr} = 0.1 \times I_R, \\ R_L &= 100 \Omega \end{aligned}$		1.5		ns

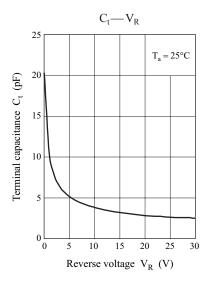
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

- 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
- 3. Absolute frequency of input and output is 1  $\ensuremath{\text{GHz}}$ 
  - \*1: t<sub>rr</sub> measurement circuit





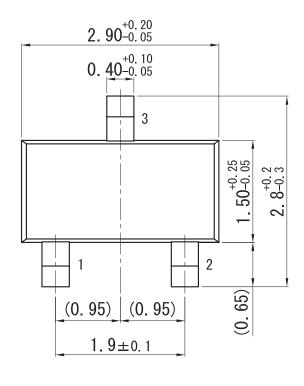


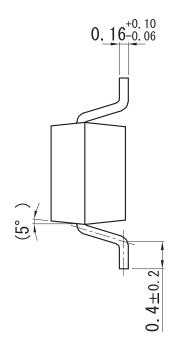


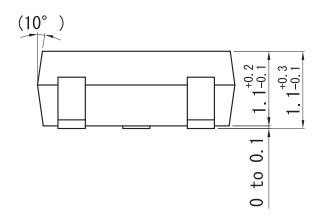
Ver. CED 2

Mini3-G3-B

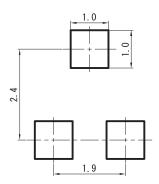
Unit: mm







### ■ Land Pattern (Reference) (Unit: mm)



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